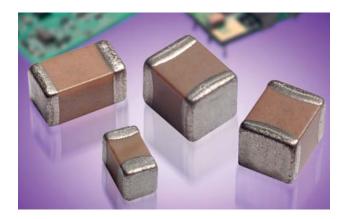
General Specifications





X7R formulations are called "temperature stable" ceramics and fall into EIA Class II materials. X7R is the most popular of these intermediate dielectric constant materials. Its temperature variation of capacitance is within $\pm 15\%$ from -55°C to +125°C. This capacitance change is non-linear.

Capacitance for X7R varies under the influence of electrical operating conditions such as voltage and frequency.

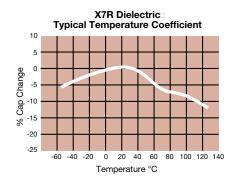
X7R dielectric chip usage covers the broad spectrum of industrial applications where known changes in capacitance due to applied voltages are acceptable.



PART NUMBER (see page 2 for complete part number explanation)

0805	<u>5</u>	<u>C</u>	103	M	A	T	<u>2</u>	A
	Voltage 4V = 4 6.3V = 6 10V = Z 16V = Y 25V = 3	Dielectric X7R = C	Capacitance Code (In pF) 2 Sig. Digits + Number of Zeros	Capacitance Tolerance $J = \pm 5\%^*$ $K = \pm 10\%$ $M = \pm 20\%$	Failure Rate A = Not Applicable	Terminations T = Plated Ni and Sn 7 = Gold Plated* Z = FLEXITERM®**	Packaging 2 = 7" Reel 4 = 13" Reel 7 = Bulk Cass. 9 = Bulk	Special Code A = Std. Product
NOTE O	50V = 5 100V = 1 200V = 2 500V = 7		a and Talaurana Ond	*≤1µF only, contact factory for additional values		*Optional termination **See FLEXITERM® X7R section	Contact Factory For Multiples	

NOTE: Contact factory for availability of Termination and Tolerance Options for Specific Part Numbers. Contact factory for non-specified capacitance values.



A Capacitance vs. Frequency

+30

+20

+10

-10

-30

1KHz

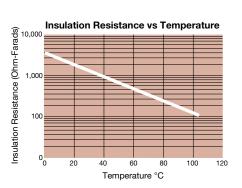
10 KHz

100 KHz

1 MHz

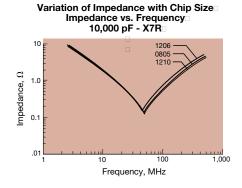
10 MHz

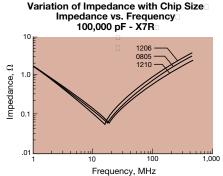
Frequency



Impedance vs. Frequency 1,000 pF vs. 10,000 pF - X7R 0805

Variation of Impedance with Cap Value









Specifications and Test Methods

	ter/Test	X7R Specification Limits	Measuring Conditions							
	perature Range	-55°C to +125°C	Temperature Cycle Chamber							
Capac	on Factor	Within specified tolerance ≤ 2.5% for ≥ 50V DC rating ≤ 3.0% for 25V DC rating ≤ 3.5% for 25V and 16V DC rating ≤ 5.0% for ≤ 10V DC rating	Freq.: 1.0 kHz ± 10% Voltage: 1.0Vrms ± .2V							
Insulation	Resistance	100,000MΩ or 1000MΩ - μ F, whichever is less	Charge device with rated voltage for 120 ± 5 secs @ room temp/humidity							
Dielectric	Strength	No breakdown or visual defects	Charge device with 300% of rated voltage for 1-5 seconds, w/charge and discharge current limited to 50 mA (max) Note: Charge device with 150% of rated voltage for 500V devices.							
	Appearance	No defects	Deflectio							
Resistance to	Capacitance Variation	≤ ±12%	Test Time: 3	30 seconds 7 1mm/sec						
Flexure Stresses	Dissipation Factor	Meets Initial Values (As Above)	V							
	Insulation Resistance	≥ Initial Value x 0.3	90 mm							
Solde	rability	≥ 95% of each terminal should be covered with fresh solder	Dip device in eutectic for 5.0 ± 0.							
	Appearance	No defects, <25% leaching of either end terminal								
	Capacitance	≤ ±7.5%	Dip device in eutectic solder at 260°C for 60 seconds. Store at room temperature for 24 ± 2 hours before measuring electrical properties.							
	Variation									
Resistance to Solder Heat	Dissipation Factor	Meets Initial Values (As Above)								
	Insulation Resistance	Meets Initial Values (As Above)								
	Dielectric Strength	Meets Initial Values (As Above)								
	Appearance	No visual defects	Step 1: -55°C ± 2°	30 ± 3 minutes						
	Capacitance Variation	≤ ±7.5%	Step 2: Room Temp	≤ 3 minutes						
Thermal Shock	Dissipation Factor	Meets Initial Values (As Above)	Step 3: +125°C ± 2°	30 ± 3 minutes						
Gilook	Insulation Resistance	Meets Initial Values (As Above)	Step 4: Room Temp	≤ 3 minutes						
	Dielectric Strength	Meets Initial Values (As Above)	Repeat for 5 cycles and measure after 24 ± 2 hours at room temperature							
	Appearance	No visual defects								
	Capacitance Variation	≤ ±12.5%	Charge device with 1.5 rated voltage (≤ 10\ test chamber set at 125°C ± 2°C							
Load Life	Dissipation Factor	≤ Initial Value x 2.0 (See Above)	for 1000 hou	,						
	Insulation Resistance	≥ Initial Value x 0.3 (See Above)	Remove from test ch at room temperatu	re for 24 ± 2 hours						
	Dielectric	Meets Initial Values (As Above)	before me	easuring.						
	Strength	· · · · · · · · · · · · · · · · · · ·								
	Appearance	No visual defects	Store in a test chamb	er set at 85°C ± 2°C/						
	Capacitance Variation	≤ ±12.5%	85% ± 5% relative hui (+48, -0) with rated	midity for 1000 hours						
Load Humidity	Dissipation Factor	≤ Initial Value x 2.0 (See Above)	Remove from chamber and stabilize at							
	Insulation Resistance	≥ Initial Value x 0.3 (See Above)	room temperature and humidity for							
	Dielectric Strength	Meets Initial Values (As Above)	- 24 ± 2 hours before measuring.							







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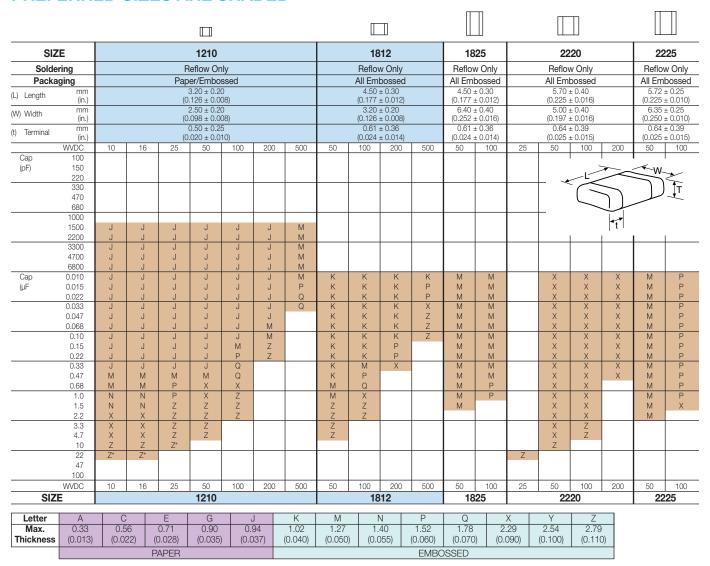
							- - - -																									
SIZE 0101				0201			0402	2		0603							0805							1206								
Soldering Reflow Only			Re	Reflow Only Reflow/Wave						Reflow/Wave							Reflow/Wave							Reflow/Wave								
Packag	ging	Paper/Embossed						All Paper				All Paper						Pape	r/Emb	ossed				Paper/Embossed								
(L) Length	mm (in.)	0.40 ± 0.02 (0.016 ± 0.0008)		.60 ± 0.)24 ± 0.			.00 ± 0. 040 ± 0.			1.60 ± 0.15 (0.063 ± 0.006)							2.01 ± 0.20 (0.079 ± 0.008)						3.20 ± 0.20 (0.126 ± 0.008)									
(W) Width	mm	0.20 ± 0.02	0.	.30 ± 0.	.03	0	$.50 \pm 0.$	10	0.81 ± 0.15 (0.032 ± 0.006)							1.25 ± 0.20							1.60 ± 0.20									
	(in.) mm	(0.008 ± 0.0008) 0.20 ± 0.02		11 ± 0.			$\frac{020 \pm 0}{25 \pm 0}$)32 ± 0. .35 ± 0.				(0.049 ± 0.008) 0.50 ± 0.25							(0.063 ± 0.008) 0.50 ± 0.25									
(t) Terminal	(in.)	(0.008 ± 0.0008)		006 ± 0.0		0.25 ± 0.15 (0.010 ± 0.006)				(0.014 ± 0.006)							(0.020 ± 0.25 (0.020 ± 0.010)							(0.020 ± 0.010)								
	WVDC	10	10	16	25	16	25	50	6.3	10	16	25	50	100	200	6.3	10	16	25	50	100	200	6.3	10	16	25	50	100	200	500		
Cap	100	A	A	A	A											l																
(pF)	150 220	A A	A A	A	A			С								l																
	330	A	A	A	A			C					G	G	G		J	J	J	J	J	J							$\overline{}$	K		
	470	А	Α	Α		1		С					G	G	G	l	J	J	J	J	J	J								K		
	680	A	A	A				С					G	G	G	_	J	J	J	J	J	J							\vdash	K		
	1000 1500	А	A A	А				C					G G	G G	G		J	J	J	J	J	J		J	J	J	J	J	J	K M		
	2200		A					C					G	G		l	J	J	Ĵ	J	Ĵ	J		J	J	Ĵ	J	Ĵ	J	M		
	3300		А				С	С					G	G			J	J	J	J	J	J		J	J	J	J	J	J	M		
	4700		Α				С	С					G	G		l	J	J	J	J	J	J		J	J	J	J	J	J	M		
Cap	6800 0.010		A			C	C						G	G		_	J	J	J	J	J	J	-	J	J	J	J	J	J	P		
(µF	0.015		А			C						G	G	4		l	J	J	J	J	J	J		J	J	J	J	J	M	Г		
(pr	0.022					C	С					G	G			l	Ĵ	Ĵ	Ĵ	Ĵ	Ĵ	N		J	Ĵ	Ĵ	Ĵ	Ĵ	M			
	0.033					С	С					G	G				J	J	J	J	N			J	J	J	J	J	М			
	0.047					С	C				G	G	G			l	J	J	J	J	N			J	J	J	J	J	M P			
	0.068		-			C	C			G	G	G	G		+	-	J	J	J	J	N N		\vdash	J	J	J	J	J	P	_		
	0.15								G	G	u	4	u			l	J	J	Ĵ	l N	N			J	Ĵ	J	J	Q				
	0.22								G	G		J*					J	J	N	N	N			J	J	J	J	Q				
	0.33																N	N	N	N	N			J	J	М	Р	Q				
	0.47											J*				l	N	N	N	N	N			M	M	M	P	Q				
	0.68									J*	J*			\vdash		\vdash	N N	N N	N N	N				M	M	Q	Q	Q				
	1.5															l	- 14	- 14	14	- 14				P	Q	Q	a	Q				
	2.2								J*										P*					Q	Q	Q		Q*				
	3.3															l																
	4.7 10															P*	P*	P*						Q* Q*	Q* Q*	Q* Q*	Q*					
	22													1	+	Г	-						Q*	Q*	Q	Q			$\overline{}$			
	47															l																
	100													_																		
	WVDC	10	10	16	25	16	25	50	6.3	10	16	25	50	100	200	6.3	10	16	25	50	100	200	6.3	10	16	25		100	200	500		
	SIZE	0101		0201			0402					0603	3			0805						1206										
Letter	А	С		E		G		J		K		М		1	V	P Q X						Υ		Z								
Max.	0.33			<u>-</u> .71	(0.90		0.94		1.02 1.27 1.4						52		.78		2.29		2.54		2.79	9							
Thickness	(0.01	3) (0.022)	(0.0	028)	(0	.035)	(0.037)	(0.04	0)	(0.05	50)	(0.0)55)	(0.0	060)	(0.	070)	(0).090)	((0.100	0.100) (0.110)								
			PAF	PER												EMBOSSED																

^{*}Optional Specifications - Contact factory





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^{*}Optional Specifications - Contact factory

